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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



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1. Scope

This specification applies to fixed metal film chip resistors rectangular type rated dissipation of 0.063 W.

2. Type Designation

RR	0816	Р	-	102	_	в	_	Т 5	_	* * *
(1)	(2)	(3)	-	(4)		(5)		(6)		(7)

(1)Product Ty	pe
---------------	----

R R fixed metal film chip resistors rectangular type

(2)Size	
0816	0.8×1.6mm

(3) Tempe	rature coefficient of resistance
Р	± 25 ppm/deg C

	11 0
Q	\pm 50ppm/deg C
R	\pm 100ppm/deg C

(4) Rated re	sistance
E24 series	Three digits of number

E24 series	Three digits of number	Example : $103 = 10 \times 10^3 = 10 \mathrm{k}\Omega$
E96 series	Four digits of number	Example : $4992 = 499 \times 10^2 = 49.9 \text{k} \Omega$ $4989 = 49.9 \Omega$
		171(7) 19.9 00

(5)Tolerance	e on rated resistance
D	$\pm 0.5\%$

(6)Quantit	y in taping	
Т5	5,000pcs/reel	
On	ly for $\pm 0.1\%$ products	

(7) Three digit code when E96 Series. See para.5.2.

 $\pm 0.1\%$

3. Physical Dimensions and Construction

Physical dimensions

В

See Fig.1.

4. Ratings

4.1 Rated resistance, Tolerance on rated resistance and Temperature coefficient of resistance

(1) Rated resistance	E24 series	100 to 330k Ω
	E96 series	100 to $332 \mathrm{k} \Omega$
(2) Tolerance on rate	d resistance	$\pm 0.1\%$ (Code: B)
(3) Temperature coef	ficient of	± 25 ppm/deg C
resistance		(Code : P)

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			11			APPD Komatsu		SUSUMU CO.,LTD	
			//			2001/8/3	TITLE:	Specification for	
			11			CHKDT. Komatsu		Chip resistor RR0816 series	
			11			2001/8/3 DRAWN			
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0		<u> </u>	11			2001/08/03		RR00-1098	
REV	CHANG.NO	NOTE.	DATE	DRAWN	APPD	22!!!			





01 100 * 25 178 49 316 73 02 102 26 182 50 324 74 03 105 27 187 51 332 75 04 107 28 191 52 340 76 05 110 * 29 196 53 348 77 06 113 30 200 * 54 357 78 07 115 31 205 55 365 79 08 118 32 210 56 374 80 09 121 33 215 57 383 81 10 124 34 221 58 392 82 11 127 35 226 59 402 83 12 130 * 36 232 60 412 84 13
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Multipliers 10° 10 ¹ 10 ² 10 ³ 10 ⁴ 10 ⁵ 10 ⁻¹ ** The resistance value duplicated in E24 series and in E96 series shall be many in E24 series only. rmance
 The resistance value duplicated in E24 series and in E96 series shall be manin E24 series only.
in E24 series only.
test method shall be as specified in IEC 60115-1. <u>dard atmospheric conditions</u> nless otherwise specified, the standard range of atmospheric conditions for mak sts is as follows; Temperature 5 to 35deg C Relative humidity 45 to 85%RH Air pressure 86 to 106kPa there is any doubt about results, measurements shall be made within the following Temperature 20± 2deg C Relative humidity 60 to 70%RH Air pressure 86 to 106kPa

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6.1 Electrical

6.1.1 Resistance and tolerance

Method;

Refer to IEC 60115-1, Sub-clause 4.5. Specification:

Not exceed the specified tolerance on rated resistance in para.4.1.(2).

6.1.2 Temperature characteristic of resistance

Method;

Resistance shall be measured under standard atmospheric conditions.

When the temperature reaches and is maintained at 100 deg C higher than the temperature of standard atmospheric conditions, resistance shall be measured again. The measurement shall be made after a period of 30 min, after each specified temperature is reached.

Specification:

Not exceed the specified temperature coefficient of resistance in para.4.1.(3).

6.1.3 Overload

Method;

A d.c. or a.c. r.m.s. voltage of 2.5 times the rated voltage shall be applied for 5 sec, and a check shall be made to see if arcing or other damage happened. Then the resistor shall be maintained without electrical load for 30 min after which the resistance shall be measured. However the applied voltage shall not exceed the maximum overload voltage.

For other procedures, refer to IEC 60115-1, Sub-clause 4.13.

Specification:

Change in resistance : $\pm (0.5\%+0.05\Omega)$

Without damage by flash over (spark, arcing), burning or breakdown etc.

6.1.4 Insulation resistance

Method;

Place the specimen on the groove of metal plate so that the edge of metal block positions almost center of both electrodes, with the surface of insulation enclosure located downward or upward and pressurize the block by a force of 1.0 ± 0.2 N.

The test voltage shall be 100 ± 15 V d.c., and maintain this voltage for about 1 min. The insulation resistance shall then be measured while applying the voltage.

For other procedures, refer to IEC 60115-1, Sub-clause 4.6.

Specification;

(1) Between electrodes and insulating enclosure.(2) Between electrodes and base material.



 $\begin{array}{c} 100 M\Omega \quad \text{or more} \\ 1000 M\Omega \quad \text{or more} \end{array}$



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6.1.5 Voltage proof

Method;

The resistor shall be tested as shown in paragraph 6.1.4. The test voltage shall be a voltage of 100V (a.c. r.m.s.) between both electrode. The voltage is gradually increased at a rate of about 100 V/s. from almost 0 V to the specified voltage and maintained as it is for 60s. +10/0s., then gradually decreased to almost 0 V. For other procedures, refer to IEC 60115-1, Sub-clause 4.7.

Specification;

Change in resistance : $\pm (0.5\% + 0.05\Omega)$

Without damage by flash over (spark, arcing), burning or breakdown etc.

6.2 Mechanical

6.2.1 Substrate bending test (Bond strength of the face plating)

Method;

Apply pressure in the direction of the arrow at a rate of about 0.5 mm/s. until bent width reaches 3 mm and hold for 30 s.



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6.2.2 Body strength					
Method;					
A load of 10 N {1.02kgf} to the center in the direction	using a R0.5 pre on of arrow and he	essure rod shal eld for 10 s.	be applied	R0.5 Pressu	urizing jig imen
Specification; Change in resistance Without mechanical dar	: ± (0.5%+ nage such as brea	-0.05 Ω) ks.	_		
6.2.3 Resistance to soldering he	eat				
Method;				<>	
(1) Solder bath method					
Preheat Temperature	100 ~ 110deg C 270± 5deg C	2 30 s. 10± 1 s.			
(2) Reflow soldering method	l				
Peak temperature	260± 5deg C	10 sec. or le	ess		
Temperature	220deg C over	60 s. max.			
The heating apparatus sh temperature.	hall be the upper	r-heated oven	and the tempe	erature shall be boa	ard surface
(3) Soldering iron method					
Bit temperature	350± 5deg C				
Time	3 +1 / 0 s.				
The resistor shall be stored	at standard atmos	pheric condition	ons for 1 hr after	r which the measure	ments shall
be made.					
For other procedures, refer	to IEC 60115-1, S	Sub-clause 4.18			
Specification:					
Change in resistance :	± (0.5%+0.05Ω)				
Without mechanical damage	ge.				
Electrical characteristics sl	hall be satisfied.				
6.2.4 Solderability					
Method;					
Temperature of solder	235± 5deg C 245± 5deg C	C (Solder all C (Solder all	oy: Sn-37Pb) oy: Sn-3Ag-0.5	Cu)	
Duration of immersion For other procedures, refer	2± 0.5 s. to IEC 60115-1,	Sub-clause 4.1	7.		
Specification:					
A new uniform coating of s	older shall cover	minimum of 95	5% of the surfac	e being immersed.	
TITLE: Specification fo	r	SUSUMU	SPEC.NO:		Rev. No.
Chip resistor RR0816	series	SSM	RR	00-1098	

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6.2.5 Solvent resistance <u>Method:</u> Immersion cleaning At normal temperature : 300 sec. Using Isopropyl alcohol. For other procedures, refer to IEC 60115-1, Sub-clause 4.29.
Specification: Marking shall be legible. Without mechanical damage and distinct damage in appearance.
<u>6.3 Endurance</u>
6.3.1 Rapid change of temperature <u>Method:</u>
1 Minimum operating temperature± 3 deg C 30 min 2 Standard atmospheric conditions 2 ~ 3 min 3 Maximum operating temperature± 2 deg C 30 min 4 Standard atmospheric conditions 2 ~ 3 min For other procedures, refer to IEC 60115-1, Sub-clause 4.19.
Specification;Change in resistance: ± (0.5%+0.05Ω)Without mechanical damage such as breaks and distinct damage in appearance.Marking shall be legible.
 <u>6.3.2 Endurance (Damp heat with load)</u> <u>Method:</u> The specimen shall be placed in the test chamber at a temperature 40± 2deg C and a relative humidity 90 to 95 %, and then subjected to a voltage cycle consisting of rated d.c. voltage application of 1 hr 30 min and rest of 30 min repeatedly for 1000 +48/0 hrs.
Specification: Change in resistance : ± (0.5%+0.05Ω) Without mechanical damage such as breaks and distinct damage in appearance. Marking shall be legible.





6.3.3 Endurance (rated load)

Method;

The specimen shall be placed in the test chamber at $70\pm 2 \deg C$, and then subjected to a voltage cycle consisting of rated d.c. voltage application of 1 hr 30 min and rest of 30 min repeatedly for 1000 + 48/0 hrs.

However the applied voltage shall not exceed the limited element voltage. For other procedures, refer to IEC 60115-1, Sub-clause 4.25.

Specification;

Change in resistance : $\pm (0.5\% + 0.05\Omega)$

Without mechanical damage such as breaks and distinct damage in appearance. Marking shall be legible.





Test board

<u>Test board A</u> (For substrate banding, adhesion test, see Fig.4) Material: Glass fabric base epoxy resin 1.6mm Copper foil, thickness 0.035 mm Solder resist coating

<u>Test board B(</u> For another test, see Fig.5) Material: Glass fabric base epoxy resin 1.6mm Copper foil, thickness 0.035 mm Solder resist coating

Mounting method

(1) Mounting method according to solder bath method

Epoxy based adhesive agent shall be applied in the middle between the lands of the test board and the resistor shall be mounted in such a way that resistor's electrodes will be evenly placed in the land area and then the adhesive agent shall be hardened. Then a methanol medium of 25% colophony by specific weight is used as flux (if non-deviant test results are assurable over the counter colophony based flux may be used) and is soldered by dipping in a molten solder bath of $260\pm 5 \deg C$ and immersed for 3 to 5 s.

(2) Mounting method according to reflow soldering method

About 200 μ m of solder cream is applied in the land portion of the test boards and the resistor shall be mounted in such a way so that the resistor's electrodes will be evenly placed on the land. It is soldered under the conditions of board surface temperature 240 to 250deg C(peak temperature) for 5 to 10 s. in an upper-portion heated oven.

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7. Packaging

Resistors shall be in Taping.

7.1 Dimensions

7.1.1 Tape packaging dimensions See Fig.6.

7.1.2 Reel dimensions See Fig.7 or Fig.8

7.2 Materials

Tape: PaperReel: Plastic

7.3 Specification of taping Refer to clause 7.1 and IEC 60286-3.

7.4 Pieces per reel

1000 pieces per reel or 5000 pieces per reel. When a quantity is 5000 pieces per reel, code "-T5" shall be added at the end of type designation. See para.2.

7.5 Marking

The label indicated following items shall be marked on single side of the reel.

- ① Type designation
- 2 Quantity
- ③ Manufacturing date code

(Month and year are marked. Refer to JIS C 5201-1 Annex 1 Table5.

- ④ Manufacturer's name
- ⑤ Country of origin
- ⁶ Shipping inspection code
- $\ensuremath{\textcircled{O}}$ Identification showing lead-free products.



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8. Precautions in use

8.1 Storage

- (1) Resistor shall be stored in a room where temperature and humidity must be controlled.
 (temperature 5 to 35 deg C, humidity 45 to 85 % RH) However, humidity keep it low, as it is possible.
- (2) Resistor shall be stored as direct sunshine doesn't hit on it.
- (3) Resistor shall be stored with no moisture, dust, a material that will make solderbility inferior, and a harmful gas (hydrogen chloride, sulfurous acid gas, and hydrogen sulfide).
- (4) Resistor shall be stored with keeping the minimum package unit with uncivilized sealed (Keep the state of the taping).

8.2 Time limit to storage

- (1) The storage time limit of the product is reckoned on the day when the product was shipped by our company and made within one year.
- (2) Confirm solderbility beforehand when you use the one that the time limit was passed.

8.3 Chip mounting

- (1) When chip are mounted on the PC board, the protection coat of resistors must not be scratched. If it will be scratched, it will make performance for moisture inferior.
- (2) In case that resistor will be soldered by soldering iron, heating shall be done on the land, and soldering iron must not hit on the resistor itself.
- (3) In case that resin coating or resin seal will be made for a PC board after chip mounting, do washing and drying it enough before coating or sealing. If ion bear or moisture will be sealed in resin coating, it will make performance for moisture inferior sometimes.

For resinous use, it is necessary to set up enough the curing conditions. As it get improper for the condition, change of a resistance value are large and are a case.

(4) According to shape, material, and pressure of clamping in chip mounting machine, there is the case that crack will be appeared on resistor.

Control a shock energy for clamping resistor under 7×10^{-4} J.

With a shock energy around clamping that says here, it is suited to a potential energy, in case that iron block of 25g is dropped naturally to the resistor placed on iron plate for the height of 2.8mm.

(5) The glue to fix a resistor on the PC board around chip mounting, it is needed high insulation resistance and great performance or moisture. And it is needed that these characteristics are not inferior in using temperature range and a hot spot temperature to be acting.

8.4 Using and Handling

- It is necessary to investigate the performance and reliability enough when using under harsh environment. Especially, the performance of the product is occasionally damaged when using with the dewy state or ion material adhered.
- (2) It is necessary to protect the edge and protection coat of resistors from mechanical stress.
- (3) Handle with care when PC board is divided or fixed on support body, because bending of PC board after chip mounting will make mechanical stress for resistors.



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- (4) Resistors shall be used within rated range shown in specification. Especially, if voltage more than specified value will be loaded to resistor, there is a case it will make damage for machine because of temperature rise depending on generation of heat, and increase resistance value or breaks.
- (5) In case that resistor is loaded a rated voltage, it is necessary to confirms temperature of a resistor and to reduce a load power according to load reduction curve, because a temperature rise of a resistor depends on influence of heat from mounting density and neighboring element.
- (6) Observe Limiting element voltage and maximum overload voltage specified in each specification.
- (7) If there is a possibility that a large voltage (pulse voltage, shock voltage) charge to resistor, It is necessary that operating condition shall be set up before use, because performance of thin film resistor is affected by a large shock voltage.

8.5 Using and Handling

Refer to EIAJ RCR-2121 -- Electronic Industries Association of Japan technological report "Fixed resistor directions guideline."



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